

Title (en)

HEAT EXCHANGER MANUFACTURING METHODS AND BRAZING FILLER METAL COMPOSITIONS USEFUL THEREIN

Title (de)

VERFAHREN ZUM HERSTELLEN VON WÄRMETAUSCHERN UND GEEIGNETE METALLISCHE ZUSAMMENSETZUNGEN ZUM LÖTEN

Title (fr)

PROCEDES PERMETTANT DE PRODUIRE UN ECHANGEUR DE CHALEUR ET COMPOSITIONS DE MÉTAL D'APPORT POUR BRASAGE UTILES POUR CES PROCEDES

Publication

EP 1317330 A1 20030611 (EN)

Application

EP 01970923 A 20010914

Priority

- US 0128651 W 20010914
- US 23375500 P 20000915
- US 94765101 A 20010906

Abstract (en)

[origin: WO0222299A1] Methods for the manufacture of assemblies which included brazed components and in which nickel/chromium-based filler metals are used wherein the manufactured assemblies are characterized by low leaching rates of nickel in water and water-based fluids, are disclosed. More specifically, there are disclosed methods for the manufacture of a heat exchanger or other assembly which method includes a brazing step, as well as a post-brazing conditioning step for treating the heat exchanger or other assembly. The manufactured heat exchangers and other assemblies are particularly useful in the handling of materials intended for human consumption such as water, beverages or food as the manufactured heat exchangers or other assemblies are characterized by reduced leaching rates of nickel into fluids passed through the heat exchanger. Brazing compositions useful in such manufactured assemblies are also described.

IPC 1-7

B23K 1/00; B23K 35/30

IPC 8 full level

B23K 1/00 (2006.01); **B23K 35/30** (2006.01); **B23K 101/14** (2006.01)

CPC (source: EP KR US)

B23K 1/0012 (2013.01 - EP US); **B23K 31/02** (2013.01 - KR); **B23K 35/304** (2013.01 - EP US); **B23K 2101/14** (2018.07 - EP US);
Y10T 29/4935 (2015.01 - EP US)

Citation (search report)

See references of WO 0222299A1

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR

DOCDB simple family (publication)

WO 0222299 A1 20020321; AT E412485 T1 20081115; AU 9087101 A 20020326; CN 100548553 C 20091014; CN 1474729 A 20040211;
DE 60136369 D1 20081211; EP 1317330 A1 20030611; EP 1317330 B1 20081029; JP 2004510582 A 20040408; JP 4959099 B2 20120620;
KR 100786880 B1 20071220; KR 20030026370 A 20030331; US 2002112350 A1 20020822; US 6749104 B2 20040615

DOCDB simple family (application)

US 0128651 W 20010914; AT 01970923 T 20010914; AU 9087101 A 20010914; CN 01818781 A 20010914; DE 60136369 T 20010914;
EP 01970923 A 20010914; JP 2002526537 A 20010914; KR 20037003749 A 20030314; US 94765101 A 20010906